

Single high speed high isolation RS485 isolation transceiver module





- Integrated high efficient isolated DC-DC converter
- High baud rate of up to 1Mbps
- Two-port isolation test voltage 5.0kVAC (Reinforced insulation)
- Operating ambient temperature range: -40° to +105°
- The bus supports maximum 128 nodes
- Set isolation and ESD bus protection in one



€ Report RoHS

The main function of the TDH301D485H2/TDH501D485H2 series is to convert a logic level signal into isolated RS485 differential level signals. The special integrated IC technology of the RS485 transceiver achieves isolation between the power supply and the signal lines isolation, does RS485 communication and protects the bus all in one and the same module. The product's isolated power supply withstands a test voltage of up to 5000VAC. Also, they can easily be embedded in the user's end equipment, to achieve fully functional RS485 network connections.

Selection Guide							
Certification	Part No.	Power Supply Input (VDC)	Baud Rate (bps)	Static Current (mA)	Maximum Operating Current(mA)	Number Of Nodes	
FNI	TDH301D485H2	3.15-3.45	1M	20	210	128	
EN	TDH501D485H2	4.75-5.25	1M	20	150	128	

Absolute Limits						
Item	Operating Conditions	Min.	Тур.	Max.	Unit	
land the Course Melhana (land many)	3.3V series	-0.7	-	5	\/D0	
Input Surge Voltage (1sec.max.)	5.0V series	-0.7	-	7	VDC	
Pin Soldering Temperature	Soldering spot 1.5mm away from case, 10s max.	-	_	300	$^{\circ}$	

3.3V series la	nput Specit	ications				
Item		Symbol	Min.	Тур.	Max.	Unit
Power Supply Input Voltage		Vcc	3.15	3.3	3.45	
TXD Logic Level	High-level	ViH	0.7V _{CC}		V _{CC} +0.5	VDC
	Low-level	VIL	0		0.8	
DVD Logic Lovel	High-level	Voн	V _{CC} -0.4		Vcc	
RXD Logic Level	Low-level	Vol			0.4	
TXD Drive Current		lτ	2		_	A
RXD Output Current		l _R	_		5	mA
Serial Interface		Compatible with + 3.3 V UART interface only				

5.0V series Input Specifications						
Item		Symbol	Min.	Тур.	Max.	Unit
Power Supply Inpu	ut Voltage	Vcc	4.75	5	5.25	
TVD I a gia I aval	High-level	ViH	0.7V _{CC}	-	Vcc+0.5	VDC
TXD Logic Level	Low-level	VIL	0	-	0.8	
DVD Logie Lovel	High-level	Voн	V _{CC} -0.4		Vcc	
RXD Logic Level	Low-level	Vol	_	-	0.4	
TXD Drive Current		It	2	-	-	Λ
RXD Output Curre	ent	l _R	_	-	10	mA

MORNSUN®

MORNSUN Guangzhou Science & Technology Co., Ltd.

Industrial Bus TDHx01D485H2 Series



Transmission Specifications						
Item		Symbol	Min.	Тур.	Max.	Unit
TXD Transmitter Delay		tτ			100	
Data Delay	RXD Receiver Delay	t₁R			100	ns
Transceiver switching delay time		Switch from receiving data to sending data		5	18	
iransceiver sv	witching delay time	Switch from sending data to receiving data		30	100	us

Output Specifications					
Item	Symbol	Min.	Тур.	Max.	Unit
Difference Level	$V_{\text{diff(d)}}$, $R_L=54 \Omega$	1.5	2	_	VDC
Difference Input Impedance	-7V≪Vcм≪+12V	96			k Ω
Built-in Pull-down Resistor			51	_	K 52
Bus Interface Protection			ESD pro	otection	

Truth Table Specification		la a d		0.44	
Transceiver Control		Input		Output	
	CON	TXD	Α	В	RXD
Send Status	0	1	1	0	1
	0	0	0	1	1
	CON	Va-V _B	RXD		
	1	>-20mV	1		
Receive Status [®]	1	≤-220mV	0		
	1	-220mV <v<sub>A-V_B<-20mV</v<sub>	Undefined state		

General Specifications		
Item	Operating Conditions	Value
Isolation Test	Electric strength test for 1 min, leakage current <1mA	5000VAC (Reinforced insulation)
Insulation Resistance	At 500VDC	1000M Ω
Operating Temperature		-40°C to +105°C
Transportation and Storage Temperature		-50°C to +125°C
Operating Humidity	Non-condensing	10% - 90%
Max. Case Temperature	Ta=25°C, Free air convection	25℃
Safety Standard		EN62368-1 (Report)
Safety Class		CLASS III
Application Environment		The presence of dust, severe vibration, shock and corrosive gas may cause damage to the product

Mechanical Specifications			
Case Material	Black flame-retardant heat-proof plastic (UL94 V-0)		
Dimensions	DIP10 (20 .00 x 17.00 x 12.80mm)		
Weight	7.2g(Typ.)		
Cooling Method	Free air convection		



Electro	Electromagnetic Compatibility (EMC)						
Engladana	CE	CISPR32/EN55032 CLASS A (see Fig.3-1)					
Emissions	RE	CISPR32/EN55032 CLASS A (see Fig.3-1)					
	ESD	IEC/EN 61000-4-2 Contact±4kV/Air±8kV (without external components, A, B port)	Perf. Criteria B				
	RS	IEC/EN 61000-4-3 10V/m (without external components)	Perf. Criteria B				
Immunity	EFT	IEC/EN 61000-4-4 ±2kV (without external components, A, B port)	Perf. Criteria B				
	Surge	IEC/EN 61000-4-5 ±2kV (line to ground) (without external components, A, B port) ±2kV (line to line)/±4kV (line to ground) (see Fig.2-2, A, B port)	Perf. Criteria B				
	CS	IEC/EN 61000-4-6 3Vr.m.s	Perf. Criteria A				

Application Precautions

- 1. Carefully read and follow the instructions before use; contact our technical support if you have any question;
- 2. Do not use the product in hazardous areas;
- 3. Use only DC power supply source for this product and AC power supply is prohibited;
- 4. It is strictly forbidden to disassemble the product privately in order to avoid product failure or malfunction;
- 5. If the external input of TXD is insufficient, the pull-up resistor should be added according to the situation;
- 6. Hot swapping is not supported.

After-sales service

- 1. Factory inspection and quality control are strictly enforced before shipping any product; please contact your local representative or our technical support if you experience any abnormal operation or possible failure of the module;
- 2. The products have a 3-year warranty period, from the date of shipment. The product will be repaired or exchanged free of charge within the warranty period for any quality problem that occurs under normal use.

Applied circuit

Refer to the RS485 Isolated Industrial Bus Interface Module Application Manual.

Design Reference

1. Typical application circuit

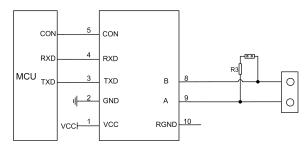


Fig. 1

Figure 1 shows a typical connection circuit for the isolated transceiver module TDH301D485H2 and TDH501D485H2. The TDH501D485H2 module's power supply must be 5V and match the module's TXD, RXD and CON pin interface level of 5V (not supporting any 3.3V system levels). Accordingly, TDH301D485H2 module's power supply must be 3.3V and match the module's TXD, RXD and CON pin interface level of 3.3V (not supporting any 5V system levels).



2. Recommended port protection circuit

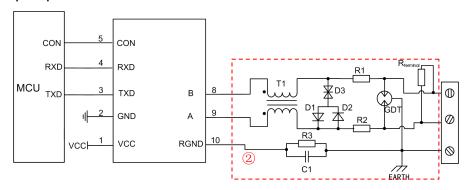


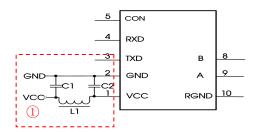
Fig. 2

Note: Ground shield of twisted wire pair reliably.

Recommended components and values:

	. 19 - 11 - 11 - 11 - 11 - 11 - 11 - 11					
Component	Recommended part, value	Component	Recommended part, value			
R3	1M Ω	R1, R2	2.7 Ω /2W			
C1	1nF, 2kV	D1, D2	1N4007			
TI	ACM2520-301-2P	D3	SMBJ8.5CA			
GDT	B3D090L	Rterminal	120 Ω			

As the modules internal A / B lines come with its own ESD protection, which generally satisfy most application environments without the need for additional ESD protection devices, as shown in the typical circuit in Figure 1. For harsh and noisy application environments such as motors, high voltage/current switches, lightning and similar however, we recommended that the user protects the module's A / B lines with additional measures and external components such as TVS, common mode inductors, gas discharge tube, shielded twisted pair of wires with the same single network Earth point. Figure 2 shows our recommended circuit diagram for such type of applications with components and values given in the table above. This recommendation is for reference only and may have to be adapted accordingly with appropriate component values in order to match the actual situation and application.



Component	Recommended part, value
C1, C2	1uF/50V
LDM	12uH

Fig. 3

3. Precautions

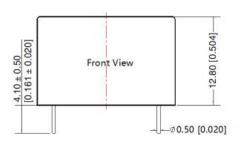
- 1) TDH501D485H2 is for 5V TTL level only (not compatible with 3.3V); TDH301D485H2 is for 3.3V TTL level only (not compatible with 5V).
- 2) Pin6 and Pin7 are not drawn. Please leave pin 10 open if unused.
- 3) We recommend using a shielded twisted pair of wires for the Data transmission line and using same single point earth connection for each of the networks.
- 4) From the truth table characteristics, it can be derived that the isolated RS-485 transceiver module's CON pin is low to send data and high when receiving data. Note that the general 485 transceiver chip control level is exactly the opposite, therefore, if the customer desires to change the level to the ordinary 485 transceiver chip control level, we recommend using a transistor circuit between the MCU and the CON feed to reverse this signal.
- 5) Reference the truth table characteristics: When the A / B line differential voltage of the series of embedded isolated RS-485 transceiver module is \geq -20mV, the modules receiving level is high and when the A / B line differential voltage is \leq -220mV the modules receiving level is low; the modules receiving level is undefined when the A / B line differential voltage is greater than -220mV but less than -20mV, so the design is to ensure that the module will not be receiving this state. Depending on the actual situation, it is up to the user of the RS-485 network design or application to decide whether to add a 120 Ω termination resistor. Avoiding data communication errors: Regardless if the RS-485 network is static or dynamic, it is essential to avoid that the differential voltage of A / B line ever comes between -220mV and -20mV.
- 4. For additional information, please refer to our application note on www.mornsun-power.com

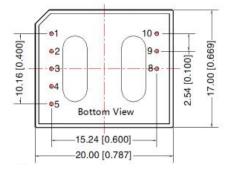
MORNSUN®

MORNSUN Guangzhou Science & Technology Co., Ltd.



Dimensind Recommended Layout

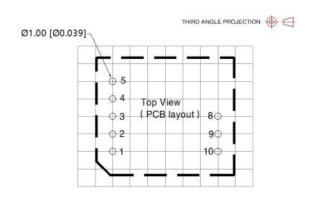




Note:

Unit: mm[inch]

Pin diameter tolerances: $\pm 0.10[\pm 0.004]$ General tolerances: $\pm 0.25[\pm 0.010]$



Note: Grid 2.54*2.54mm

Pin-Out		
Pin	Mark	Function
1	VCC	Input Power
2	GND	GND
3	TXD	TDH_D485H(H2, H-E) Sending Pin
4	RXD	TDH_D485H(H2, H-E) Receiving Pin
5	CON	Sending&Receiving Control Pin
8	В	TDH_D485H(H2, H-E) B Pin
9	Α	TDH_D485H(H2, H-E) A Pin
10	RGND	Isolation Power Output RGND

Notes:S

- 1. For additional information on Product Packaging please refer to www.mornsun-power.com. The Packaging bag number: 58220015;
- 2. It is recommended that do not open hole on the PCB to avoid thermal deformation of the product base, if customer uses this product to solder by wave soldering;
- 3. Unless otherwise specified, parameters in this datasheet were measured under the conditions of Ta=25°C, humidity<75%RH with nominal input voltage and rated output load;
- 4. All index testing methods in this datasheet are based on company corporate standards;
- 5. The above are the performance indicators of the product models listed in this datasheet. Some indicators of non-standard models will exceed the above requirements. For details, please contact our technical staff;
- 6. We can provide product customization service, please contact our technicians directly for specific information;
- 7. Products are related to laws and regulations: see "Features" and "EMC";
- 8. Our products shall be classified according to ISO14001 and related environmental laws and regulations, and shall be handled by qualified units.

MORNSUN Guangzhou Science & Technology Co., Ltd.

Address: No. 5, Kehui St. 1, Kehui Development Center, Science Ave., Guangzhou Science City, Huangpu District, Guangzhou, P. R. China Tel: 86-20-38601850 Fax: 86-20-38601272 E-mail: info@mornsun.cn www.mornsun-power.com

MORNSUN®

MORNSUN Guangzhou Science & Technology Co., Ltd.